# UNISONIC TECHNOLOGIES CO., LTD

D4N60-KW Power MOSFET

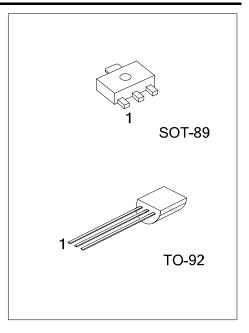
## 0.4A, 600V N-CHANNEL POWER MOSFET

#### ■ DESCRIPTION

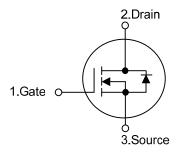
The UTC **D4N60-KW** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

#### ■ FEATURES

- \*  $R_{DS(ON)}$  < 21 $\Omega$  @  $V_{GS}$  = 10 V,  $I_D$  = 0.2A
- \* Fast Switching Capability
- \* Avalanche Energy Specified
- \* Improved dv/dt Capability, High Ruggedness



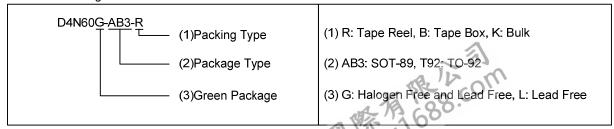
#### ■ SYMBOL



## **■ ORDERING INFORMATION**

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
D4N60L-AB3-R	D4N60G-AB3-R	SOT-89	G	D	S	Tape Reel	
D4N60L-T92-B	D4N60G-T92-B	TO-92	G	D	S	Tape Box	
D4N60L-T92-K	D4N60G-T92-K	TO-92	G	D	S	Bulk	

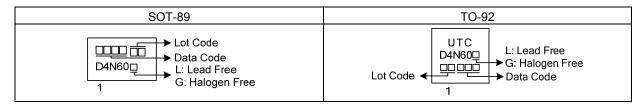
Note: Pin Assignment: G: Gate D: Drain S: Source



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**D4N60-KW Power MOSFET** 

### **MARKING**





D4N60-KW Power MOSFET

## ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{DSS}$	600	V	
Gate-Source Voltage		$V_{GSS}$	±30	V	
Continuous Drain Current		I <sub>D</sub>	0.4	Α	
Pulsed Drain Current		I <sub>DM</sub>	1.6	Α	
Avalanche Energy	Single Pulsed	E <sub>AS</sub>	10 (Note 3)	mJ	
Power Dissipation	SOT-89	J	625	mW	
	TO-92	P <sub>D</sub>	425	mW	
Junction Temperature		TJ	150	°C	
Storage Temperature		T <sub>STG</sub>	-55 ~ <b>+</b> 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 125mH,  $I_{AS}$  = 0.4A,  $V_{DD}$  = 25V,  $R_G$  = 25  $\Omega$ , Starting  $T_J$  = 25°C

#### ■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		$\theta_{JA}$	180	°C/W
Junction to Case	SOT-89	0	88	°C/W
	TO-92	θ <sub>JC</sub>	38	°C/W

## ■ ELECTRICAL CHARACTERISTICS (T<sub>C</sub> =25°C, unless otherwise specified)

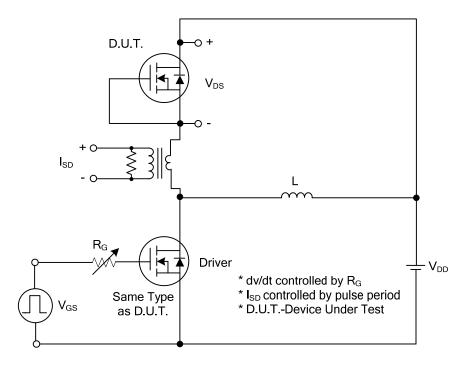
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	600			V
Drain-Source Leakage Current		I <sub>DSS</sub>	$V_{DS} = 600V, V_{GS} = 0V$			1	μΑ
			$V_{DS} = 480V$ , $T_C = 125$ °C			100	μΑ
Gate-Source Leakage Current	Forward	- I <sub>GSS</sub>	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_{J}$	I <sub>D</sub> =250μA,Referenced to 25°C		0.6		V/°C
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$			4.0	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	$V_{GS} = 10 \text{ V}, I_D = 0.2 \text{A}$		17	21	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	nput Capacitance				70		pF
Output Capacitance		Coss	$V_{DS} = 25V, V_{GS} = 0V, f = 1MHz$		13		pF
Reverse Transfer Capacitance		$C_{RSS}$			5		pF
<b>SWITCHING CHARACTERISTIC</b>	S						
Total Gate Charge		$Q_G$	V <sub>DS</sub> = 50V,I <sub>D</sub> = 0.4A,		6		nC
Gate-Source Charge		$Q_GS$	V <sub>GS</sub> = 50V,I <sub>D</sub> = 0.4A, V <sub>GS</sub> = 10V (Note 1, 2)		1.1		nC
Gate-Drain Charge		$Q_GD$	VGS= 10V (Note 1, 2)		1.0		nC
Furn-On Delay Time		$t_{D(ON)}$			10		ns
Turn-On Rise Time		$t_R$	$V_{DD} = 30V, I_D = 0.4A,$		25		ns
Turn-Off Delay Time Turn-Off Fall Time		t <sub>D(OFF)</sub>	$R_G = 25\Omega \text{ (Note 1, 2)}$		22		ns
		$t_{F}$			25		ns
<b>SOURCE- DRAIN DIODE RATIN</b>	GS AND CI	HARACTERIST	rics A liz c	0			ā.
Maximum Continuous Drain-Source Diode Forward Current		Is	K BE CO.			0.4	Α
			1 18 680.			0.4	^
Maximum Pulsed Drain-Source Diode Forward Current		I <sub>SM</sub>	21/2			1.6	Α
		ISM	100			1.0	
Drain-Source Diode Forward Voltage		$V_{SD}$	$V_{GS} = 0V$ , $I_{S} = 0.4A$			1.4	V

Notes: 1. Pulse Test : Pulse width ≤ 300µs, Duty cycle ≤ 2%.

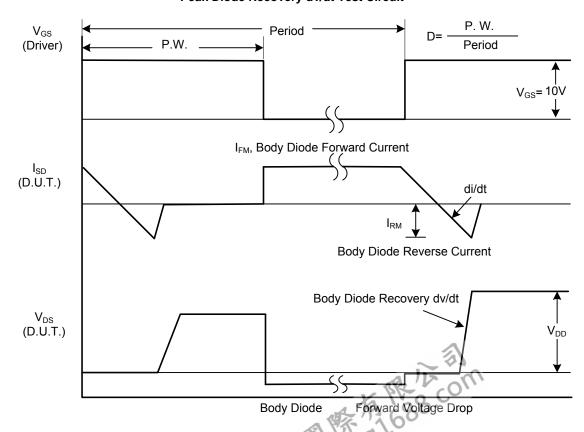
2. Essentially independent of operating ambient temperature.



### ■ TEST CIRCUITS AND WAVEFORMS

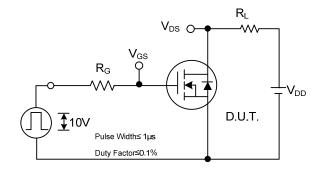


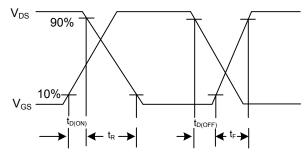
## Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

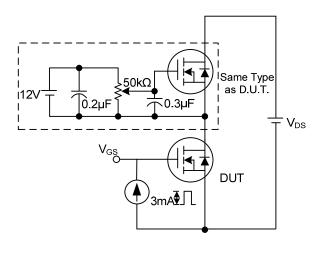
## **TEST CIRCUITS AND WAVEFORMS (Cont.)**

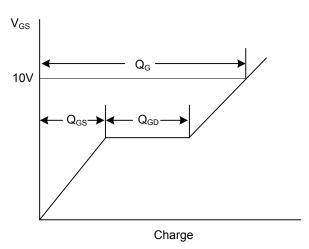




**Switching Test Circuit** 

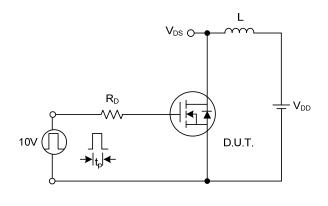
**Switching Waveforms** 

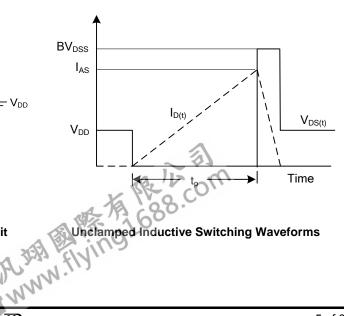




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 





**Unclamped Inductive Switching Test Circuit** 

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